

EV317136323

Inventor: Arup Bhattacharyya

Title: Semiconductor-On-Insulator Thin Film Transistor Constructions

Assignee: Micron Technology, Inc.

INFORMATION DISCLOSURE STATEMENT


PURSUANT TO 37 C.F.R. §§1.56, 1.97 AND 1.98

In compliance with 37 C.F.R. §§1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a divisional of co-pending application Serial No. 10/243,180 filed September 12, 2002. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. §1.98(d) and MPEP §609(2). No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: JULY 22, 2003 Attorney: 

David G. Latwesen, Ph.D. Reg. #38,533
WELLS ST. JOHN P.S.

Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. M122-2362		PRIORITY SERIAL NO 10/243,180	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)				APPLICANT Arup Bhattacharyya			
				PRIORITY FILING DATE September 12, 2002		PRIORITY GROUP 2818	
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)							
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	BJ		van Meer, H. et al., "Ultra-Thin Film Fully-Depleted SOI CMOS with Raised G/S/D Device Architecture for Sub-100
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